

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor : Wen-Ching Chen :
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Patent No. : 6,828,543 : Mail Stop PGPUB
Issued : 7 December 2004
Title : FLIP CHIP PACKAGE STRUCTURE FOR AN
IMAGE SENSOR AND AN IMAGE SENSE
MODULE WITH THE FLIP CHIP PACKAGE
STRUCTURE

REQUEST FOR PUBLICATION FEE REFUND

Mail Stop PGPUB
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

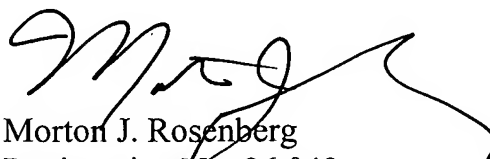
Sir:

The above-referenced patent has issued prior to the publication date and there was no publication of the patent application.

The Publication Fee has previously been paid and a refund of \$300.00 is requested.

The refund of the Publication Fee should be credited to Deposit Account 18-2011.

Respectfully submitted,
FOR: ROSENBERG, KLEIN & LEE


Morton J. Rosenberg
Registration No. 26,049

Dated: 9 Dec. 2004

Suite 101
3458 Ellicott Center Drive
Ellicott City, MD 21043
Tel: 410-465-6678

Customer No.
04586